





(1.27 mm) .050" **MECF SERIES**

ICRO EDGE CARD SOCKET

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?MECF-DV

Insulator Material:

–01=Black Liquid Crystal Polymer -02=Natural Liquid Crystal Polymer Contact Material: Plating:

Sn or Au over
50 µ" (1.27 µm) Ni
Operating Temp Range:
-55 °C to +125 °C
Current Rating: 3.5 A per pin

(2 adjacent pins powered) Voltage Rating: 280 VAC

RoHS Compliant:

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (05-30) (0.15 mm) .006" max (40-50) (.004" stencil solution may be available: contact IPG@samtec.com)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



ALSO AVAILABLE (MOQ Required)

- · Non-polarized
- · Other platings Contact Samtec.

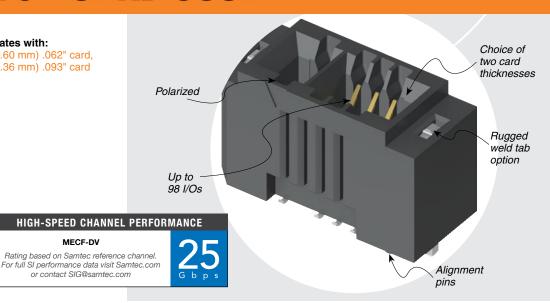
Notes:

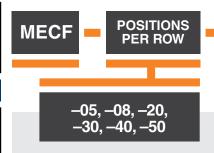
While optimized for 50 Ω applications, this connector with alternative signal/ground patterns may also perform well in certain 75 Ω applications. Contact Samtec for further information.

Some sizes, styles and options are non-standard, non-returnable.

Mates with:

1.60 mm) .062" card, (2.36 mm) .093" card





Α

(14.27) .562

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(1.27)

.050

(10.46) .412 | (8.64) .340 | (14.53) .572

(12.45) .490

(29.51) 1.162 (27.69) 1.090 (33.58) 1.322

(42.21) 1.662 (40.39) 1.590 (46.28) 1.822 (44.20) 1.740

(54.91) 2.162 (53.09) 2.090 (58.98) 2.322 (56.90) 2.240 (67.61) 2.662 (65.79) 2.590 (71.68) 2.822 (69.60) 2.740

(18.34) .722

POSITIONS PER ROW

-05

-08

-20

-30 -40

-50

02

(8.50)

(1.32) .052 -DIA

MECF-DV

-01 = (1.60 mm) .062" thick card

CARD

THICKNESS

-02 (2.36 mm) .093" thick card

(12.45) .490

(16.26) .640

(31.50) 1.240

(5.60)

-01

(1.55)

.061

(8.78)

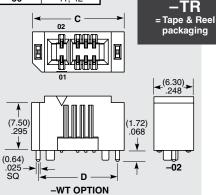
.025 SQ

= 10 μ" (0.25 μm) Gold on contact, Matte Tin on tail

PLATING

OPTION

POSITIONS PER ROW	POLARIZED POSITIONS (No Contact)
-05	3, 4
-08	5, 6
-20	15, 16
-30	21, 22
-40	31, 32
-50	41 42



DV

OPTION

-WT

= Weld Tabs

(Standard on

-02 card thickness.

optional on -01

card thickness)

–K = (5.00 mm) .197" DIA (-01 card thickness)

(5.70 mm) .224" DIA

(-02 card thickness) Polyimide film pick & place pad (-TR only)

Due to technical progress, all designs, specifications and components are subject to change without notice.

(1.10)

WWW.SAMTEC.COM